








APPLICABLE STANDARD							
RATING	OPERATING TEMPERATURE RANGE	-40°C TO + 85°C (NOTE 1) 		STORAGE TEMPERATURE RANGE	-10°C TO + 60°C (NOTE 2)		
	OPERATING HUMIDITY RANGE	40% TO + 80%		STORAGE HUMIDITY RANGE	40% TO + 70% (NOTE 2)		
	VOLTAGE	250V AC		UL・CSA RATING	VOLTAGE	30V AC	
	CURRENT	AWG 22 TO 26 : 2A AWG 28 : 1A AWG 30 : 0.5A			CURRENT	AWG 22 : 2A AWG 24 TO 28 : 1A AWG 30 : 0.5A	
SPECIFICATIONS							
ITEM		TEST METHOD		REQUIREMENTS		QT	AT
CONSTRUCTION							
GENERAL EXAMINATION		VISUALLY AND BY MEASURING INSTRUMENT.		ACCORDING TO DRAWING.		X	X
MARKING		CONFIRMED VISUALLY.				X	X
ELECTRIC CHARACTERISTICS							
CONTACT RESISTANCE		100mA (DC OR 1000 Hz).		30mΩ MAX.		X	—
INSULATION RESISTANCE		500V DC.		1000MΩ MIN.		X	—
VOLTAGE PROOF		650V AC FOR 1 min.		NO FLASHOVER OR BREAKDOWN.		X	—
MECHANICAL CHARACTERISTICS							
MECHANICAL OPERATION		50 TIMES INSERTIONS AND EXTRACTIONS.		① CONTACT RESISTANCE: 30mΩ MAX. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.		X	—
VIBRATION		FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 2 h, FOR 3 DIRECTIONS.		① NO ELECTRICAL DISCONTINUITY OF 1μs. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.		X	—
SHOCK		490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.				X	—
ENVIRONMENTAL CHARACTERISTICS							
DAMP HEAT (STEADY STATE)		EXPOSED AT 40 ± 2 °C, 90 TO 95 %, 96 h.		① CONTACT RESISTANCE: 30mΩ MAX. ② INSULATION RESISTANCE: 500MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.		X	—
RAPID CHANGE OF TEMPERATURE		TEMPERATURE -55→5 TO 35→+85 →5 TO 35 °C TIME 30→10 TO 15 →30 →10 TO15 min UNDER 5 CYCLES.		① CONTACT RESISTANCE: 30mΩ MAX. ② INSULATION RESISTANCE: 1000MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.		X	—
	COUNT	DESCRIPTION OF REVISIONS		DESIGNED		CHECKED	DATE
	2	DIS-H-008928		HT. SATO		TS. FUKUSHIMA	14. 07. 16
				APPROVED	TS. SAKATA	08. 04. 01	
				CHECKED	TS. KUMAZAWA	08. 04. 01	
				DESIGNED	KT. ISHII	08. 04. 01	
				DRAWN	YK. NAKATSU	08. 03. 13	
Note QT:Qualification Test AT:Assurance Test X:Applicable Test				DRAWING NO.		ELC4-163554-05	
	SPECIFICATION SHEET			PART NO.		DF11C-*DP-2V (57)	
	HIROSE ELECTRIC CO., LTD.			CODE NO.		CL543	 1/2

SPECIFICATIONS					
ITEM	TEST METHOD	REQUIREMENTS	QT	AT	
RESISTANCE TO SOLDERING HEAT	1) AUTOMATIC SOLDERING (REFLOW) 《REFLOW AREA》 MAX 250℃ WITHIN 10 sec. MIN 230℃ WITHIN 60 sec. 《PREHEATING AREA》 150 TO 180℃ 90 TO 120 sec. PUT THROUGH IN REFROW FUMACE TWICE. FEAVE IN AMBIENT TEMPERATURE AND HUMIDITY FOR 1 HOUR. CONNEVCTOR TEMPERATURE TO BE AMBIENT FOR SECOND REFLOW. 2) MANUAL SOLDERING SOLDERING IRON TEMPERATURE :290±10℃, SOLDERING TIME :3s. NO STRENGTH ON CONTACT.	NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.	X	—	
SOLDERABILITY	SOLDERED AT SOLDER TEMPERATURE, 230±5℃ FOR IN IMMERSION , DURATION, 3 s.	A NEW UNIFORM COATING OF SOLDER SHALL COVER MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.	X	—	
REMARKS NOTE 1:INCLUDING THE TEMPERATURE RISE BY CURRENT. NOTE 2:APPLY TO THE CONDITION OF LONG TERM STORAGE FOR UNUSED PRODUCTS BEFORE PCB ON BOARD , AFTER PCB BOARD , OPERATING TEMPERATURE AND HUMIDITY RANGE IS APPLIED FOR INTERM STORAGE DURING TRANSPORTATION. NOTE 3:THE TEMPERATURE PROFILE SHALL BE APPLIED WITHIN 168 HOURS AFTER OPENING MOISTURE-PROOF PACKAGING. WHEN 168 HOURS PASSED AFTER OPENING , APPLY THE BOTTOM REQUIREMENTS. 《REFLOW AREA》 MAX 240℃ WITHIN 10 sec. MIN 230℃ WITHIN 60 sec. 《PREHEATING AREA》 150 TO 180℃ 90 TO 120 s.					
Unless otherwise specifid , refer to IEC 60512 					
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